	Туре	L#	Hits	Search Text	DBs	Time Stamp	C o m m e i	r D ef in	ro
1	BRS	L1	43984	(pattern\$3 same (Ti or titanium or Al or aluminum or Ta or tantalum or "hard mask")) and etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB			I nessearch/enevalcould not be a borted be caus	1
2	BRS	L8	14096	(pattern\$3 near5 (Ti or titanium or Al or aluminum or Ta or tantalum)) and etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:55			0
3	BRS	L15	5262	8 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:58			0

	Туре	L#	Hits	Search Text	DBs	Time Stamp	C o m m	inirs
4	BRS	L22	9018	(pattern\$3 near5 (Ti or titanium or Al or aluminum or Ta or tantalum)) and etch\$315 and (plasma or dry or rie or ("reactive ion" adj etch\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:49		Truncation over
5	BRS	L23	9011	8 and (plasma or dry or rie or ("reactive ion" adj etch\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:49		0
6	BRS	L30	3855	23 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:50		0
7	BRS	L37	1658	30 and @pd<=19970120	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:58		0
8	BRS	L44	830	(pattern\$3 near5 ((Ti or titanium or Al or aluminum or Ta or tantalum) adj5 mask)) and etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:56		0
9	BRS	L51	300	44 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:58		0
10	BRS	L58	91	44 and 216/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:58		0

	Туре	L#	Hits	Search Text	DBs	Time Stamp	C o m m	D ef in iti	Er
11	BRS	L65	155	51 and @pd<=19970120	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 17:39			0
12	BRS	L72	56	58 and @pd<=19970120	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 16:59			0
13	BRS	L82	138	65 not 72	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/15 17:39			0